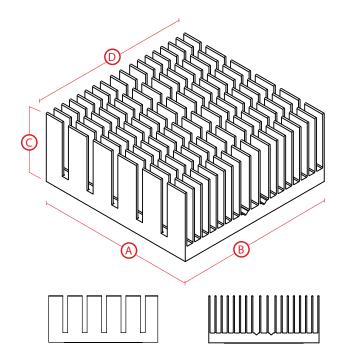


High Performance BGA Cooling Solutions w/ Thermal Tape Attachment

ATS PART # ATS-55150D-C2-R0

Features & Benefits

- » High efficiency cross-cut fin design provides low pressure drop characteristics
- » Large surface area increases heat sink performance
- » Designed for BGAs and surface mount packages
- » Comes preassembled with high performance thermal interface material



Thermal Performance

*Image above is for illustration purposes only.

AIR VELOCITY		THERMAL RESISTANCE		
FT/MIN	M/S	°C/W (UNDUCTED FLOW)	°C/W (DUCTED FLOW)	
200	1.0	29.5	NA	
300	1.5	27.9		
400	2.0	24.2		
500	2.5	21.7		
600	3.0	19.9		
700	3.5	18.5		
800	4.0	17.3		

Product Details

DIMENSION A	DIMENSION B	DIMENSION C	DIMENSION D	INTERFACE MATERIAL	FINISH
15 mm	15 mm	9.5 mm	15 mm	SAINT-GOBAIN C675	BLACK-ANODIZED

NOTES

- Dimension C = heat sink height from bottom of the base to the top of the fin field.
- Thermal performance data are provided for reference only. Actual performance may vary by application.
- ATS reserves the right to update or change its products without notice to improve the design or performance.
- Contact ATS to learn about custom options available.



For more information, to find a distributor or to place an order, visit www.qats.com or call: 781.769.2800 (North America); +31 (0) 3569 84715 (Europe).